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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

| | |
|--------------------------------|---|
| Product Status | Obsolete |
| Number of LABs/CLBs | 2560 |
| Number of Logic Elements/Cells | 2560 |
| Total RAM Bits | 32768 |
| Number of I/O | 92 |
| Number of Gates | 162000 |
| Voltage - Supply | 1.71V ~ 1.89V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 85°C (TJ) |
| Package / Case | 144-LQFP |
| Supplier Device Package | 144-TQFP (20x20) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/ep20k60etc144-2x |

| Table 2. Additional APEX 20K Device Features <i>Note (1)</i> | | | | | | |
|---|-----------|-----------|-----------|-----------|------------|------------|
| Feature | EP20K300E | EP20K400 | EP20K400E | EP20K600E | EP20K1000E | EP20K1500E |
| Maximum system gates | 728,000 | 1,052,000 | 1,052,000 | 1,537,000 | 1,772,000 | 2,392,000 |
| Typical gates | 300,000 | 400,000 | 400,000 | 600,000 | 1,000,000 | 1,500,000 |
| LEs | 11,520 | 16,640 | 16,640 | 24,320 | 38,400 | 51,840 |
| ESBs | 72 | 104 | 104 | 152 | 160 | 216 |
| Maximum RAM bits | 147,456 | 212,992 | 212,992 | 311,296 | 327,680 | 442,368 |
| Maximum macrocells | 1,152 | 1,664 | 1,664 | 2,432 | 2,560 | 3,456 |
| Maximum user I/O pins | 408 | 502 | 488 | 588 | 708 | 808 |

Note to Tables 1 and 2:

- (1) The embedded IEEE Std. 1149.1 Joint Test Action Group (JTAG) boundary-scan circuitry contributes up to 57,000 additional gates.

Additional Features

- Designed for low-power operation
 - 1.8-V and 2.5-V supply voltage (see [Table 3](#))
 - MultiVolt™ I/O interface support to interface with 1.8-V, 2.5-V, 3.3-V, and 5.0-V devices (see [Table 3](#))
 - ESB offering programmable power-saving mode

Table 3. APEX 20K Supply Voltages

| Feature | Device | |
|---|----------------------------------|--|
| | EP20K100 EP20K200 EP20K400 | EP20K30E EP20K60E EP20K100E EP20K160E EP20K200E EP20K300E EP20K400E EP20K600E EP20K1000E EP20K1500E |
| Internal supply voltage (V_{CCINT}) | 2.5 V | 1.8 V |
| MultiVolt I/O interface voltage levels (V_{CCIO}) | 2.5 V, 3.3 V, 5.0 V | 1.8 V, 2.5 V, 3.3 V, 5.0 V <i>(1)</i> |

Note to Table 3:

- (1) APEX 20KE devices can be 5.0-V tolerant by using an external resistor.

- Windows-based PCs, Sun SPARCstations, and HP 9000 Series 700/800 workstations
- Altera MegaCore® functions and Altera Megafunction Partners Program (AMPPSM) megafunctions
 - NativeLink™ integration with popular synthesis, simulation, and timing analysis tools
 - Quartus II SignalTap® embedded logic analyzer simplifies in-system design evaluation by giving access to internal nodes during device operation
 - Supports popular revision-control software packages including PVCS, Revision Control System (RCS), and Source Code Control System (SCCS)

Table 4. APEX 20K QFP, BGA & PGA Package Options & I/O Count Notes (1), (2)

| Device | 144-Pin TQFP | 208-Pin PQFP RQFP | 240-Pin PQFP RQFP | 356-Pin BGA | 652-Pin BGA | 655-Pin PGA |
|------------|-----------------|-------------------------|-------------------------|-------------|-------------|-------------|
| EP20K30E | 92 | 125 | | | | |
| EP20K60E | 92 | 148 | 151 | 196 | | |
| EP20K100 | 101 | 159 | 189 | 252 | | |
| EP20K100E | 92 | 151 | 183 | 246 | | |
| EP20K160E | 88 | 143 | 175 | 271 | | |
| EP20K200 | | 144 | 174 | 277 | | |
| EP20K200E | | 136 | 168 | 271 | 376 | |
| EP20K300E | | | 152 | | 408 | |
| EP20K400 | | | | | 502 | 502 |
| EP20K400E | | | | | 488 | |
| EP20K600E | | | | | 488 | |
| EP20K1000E | | | | | 488 | |
| EP20K1500E | | | | | 488 | |

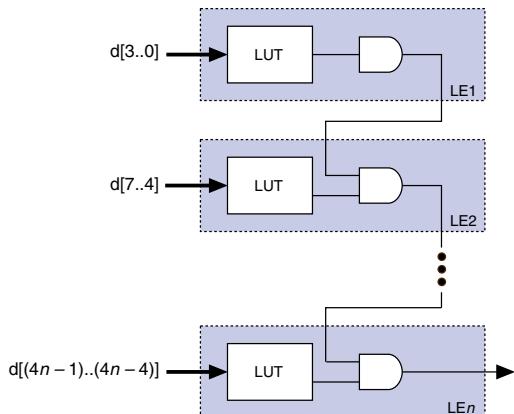
Cascade Chain

With the cascade chain, the APEX 20K architecture can implement functions with a very wide fan-in. Adjacent LUTs can compute portions of a function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical AND or logical OR (via De Morgan's inversion) to connect the outputs of adjacent LEs. Each additional LE provides four more inputs to the effective width of a function, with a short cascade delay. Cascade chain logic can be created automatically by the Quartus II software Compiler during design processing, or manually by the designer during design entry.

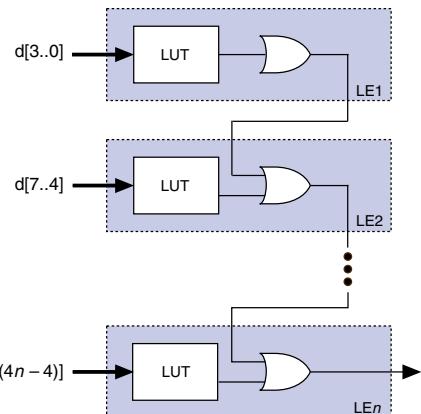
Cascade chains longer than ten LEs are implemented automatically by linking LABs together. For enhanced fitting, a long cascade chain skips alternate LABs in a MegaLAB structure. A cascade chain longer than one LAB skips either from an even-numbered LAB to the next even-numbered LAB, or from an odd-numbered LAB to the next odd-numbered LAB. For example, the last LE of the first LAB in the upper-left MegaLAB structure carries to the first LE of the third LAB in the MegaLAB structure. [Figure 7](#) shows how the cascade function can connect adjacent LEs to form functions with a wide fan-in.

Figure 7. APEX 20K Cascade Chain

AND Cascade Chain



OR Cascade Chain



The counter mode uses two three-input LUTs: one generates the counter data, and the other generates the fast carry bit. A 2-to-1 multiplexer provides synchronous loading, and another AND gate provides synchronous clearing. If the cascade function is used by an LE in counter mode, the synchronous clear or load overrides any signal carried on the cascade chain. The synchronous clear overrides the synchronous load. LEs in arithmetic mode can drive out registered and unregistered versions of the LUT output.

Clear & Preset Logic Control

Logic for the register's clear and preset signals is controlled by LAB-wide signals. The LE directly supports an asynchronous clear function. The Quartus II software Compiler can use a NOT-gate push-back technique to emulate an asynchronous preset. Moreover, the Quartus II software Compiler can use a programmable NOT-gate push-back technique to emulate simultaneous preset and clear or asynchronous load. However, this technique uses three additional LEs per register. All emulation is performed automatically when the design is compiled. Registers that emulate simultaneous preset and load will enter an unknown state upon power-up or when the chip-wide reset is asserted.

In addition to the two clear and preset modes, APEX 20K devices provide a chip-wide reset pin (DEV_CLRn) that resets all registers in the device. Use of this pin is controlled through an option in the Quartus II software that is set before compilation. The chip-wide reset overrides all other control signals. Registers using an asynchronous preset are preset when the chip-wide reset is asserted; this effect results from the inversion technique used to implement the asynchronous preset.

FastTrack Interconnect

In the APEX 20K architecture, connections between LEs, ESBs, and I/O pins are provided by the FastTrack Interconnect. The FastTrack Interconnect is a series of continuous horizontal and vertical routing channels that traverse the device. This global routing structure provides predictable performance, even in complex designs. In contrast, the segmented routing in FPGAs requires switch matrices to connect a variable number of routing paths, increasing the delays between logic resources and reducing performance.

The FastTrack Interconnect consists of row and column interconnect channels that span the entire device. The row interconnect routes signals throughout a row of MegaLAB structures; the column interconnect routes signals throughout a column of MegaLAB structures. When using the row and column interconnect, an LE, IOE, or ESB can drive any other LE, IOE, or ESB in a device. See [Figure 9](#).

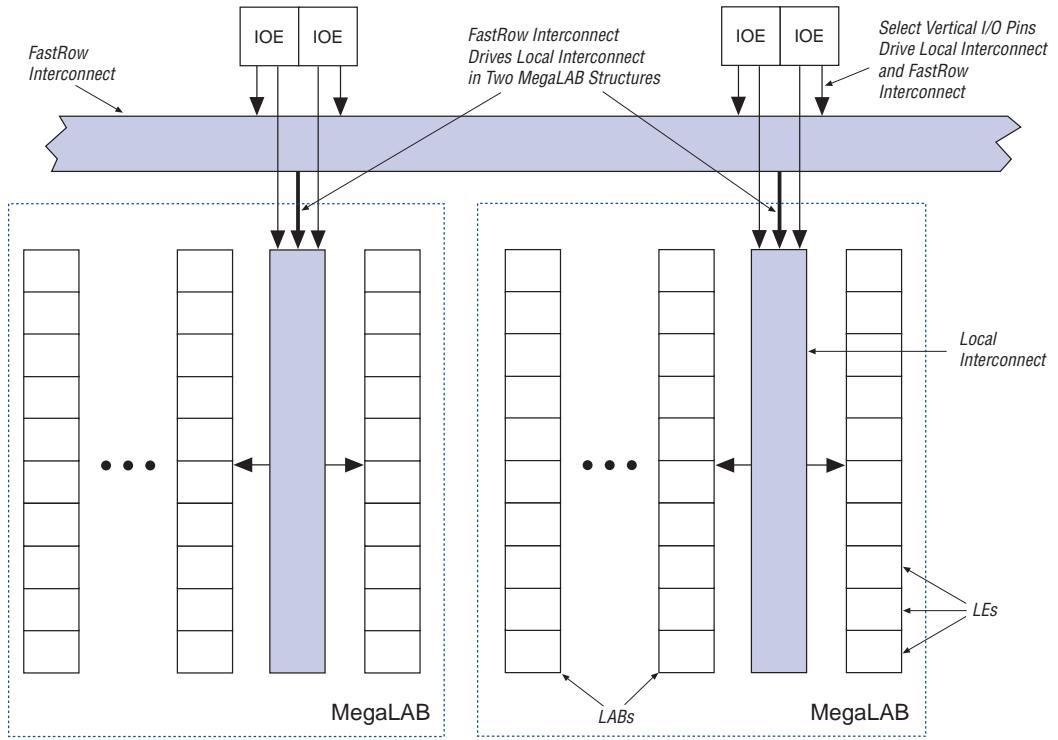
Figure 12. APEX 20KE FastRow Interconnect

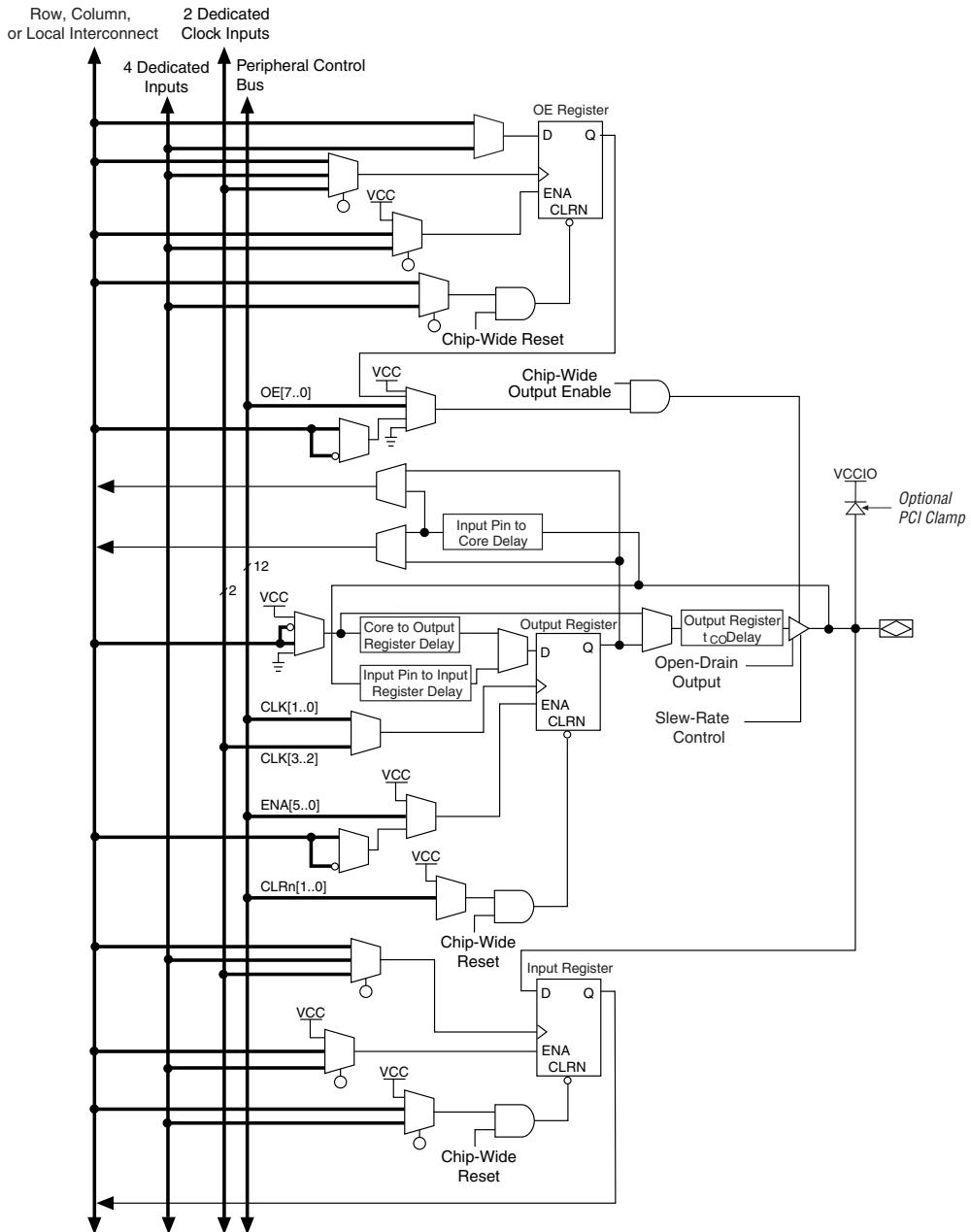
Table 9 summarizes how various elements of the APEX 20K architecture drive each other.

Table 10 describes the APEX 20K programmable delays and their logic options in the Quartus II software.

| Table 10. APEX 20K Programmable Delay Chains | |
|---|---|
| Programmable Delays | Quartus II Logic Option |
| Input pin to core delay | Decrease input delay to internal cells |
| Input pin to input register delay | Decrease input delay to input register |
| Core to output register delay | Decrease input delay to output register |
| Output register t_{CO} delay | Increase delay to output pin |

The Quartus II software compiler can program these delays automatically to minimize setup time while providing a zero hold time. Figure 25 shows how fast bidirectional I/Os are implemented in APEX 20K devices.

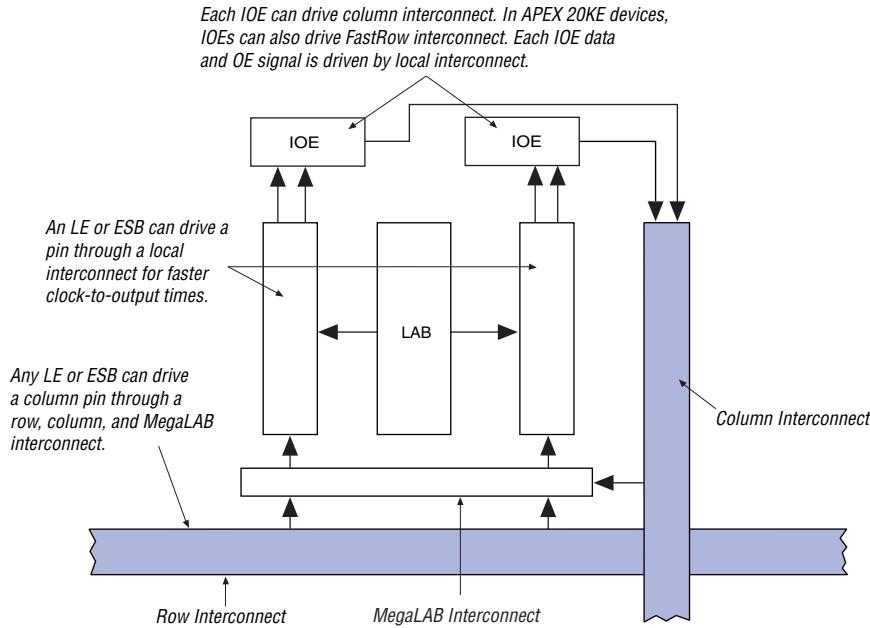
The register in the APEX 20K IOE can be programmed to power-up high or low after configuration is complete. If it is programmed to power-up low, an asynchronous clear can control the register. If it is programmed to power-up high, the register cannot be asynchronously cleared or preset. This feature is useful for cases where the APEX 20K device controls an active-low input or another device; it prevents inadvertent activation of the input upon power-up.

Figure 25. APEX 20K Bidirectional I/O Registers Note (1)**Note to Figure 25:**

- (1) The output enable and input registers are LE registers in the LAB adjacent to the bidirectional pin.

Figure 28 shows how a column IOE connects to the interconnect.

Figure 28. Column IOE Connection to the Interconnect



Dedicated Fast I/O Pins

APEX 20KE devices incorporate an enhancement to support bidirectional pins with high internal fanout such as PCI control signals. These pins are called Dedicated Fast I/O pins (FAST1, FAST2, FAST3, and FAST4) and replace dedicated inputs. These pins can be used for fast clock, clear, or high fanout logic signal distribution. They also can drive out. The Dedicated Fast I/O pin data output and tri-state control are driven by local interconnect from the adjacent MegaLAB for high speed.

Advanced I/O Standard Support

APEX 20KE IOEs support the following I/O standards: LVTTL, LVC MOS, 1.8-V I/O, 2.5-V I/O, 3.3-V PCI, PCI-X, 3.3-V AGP, LVDS, LVPECL, GTL+, CTT, HSTL Class I, SSTL-3 Class I and II, and SSTL-2 Class I and II.

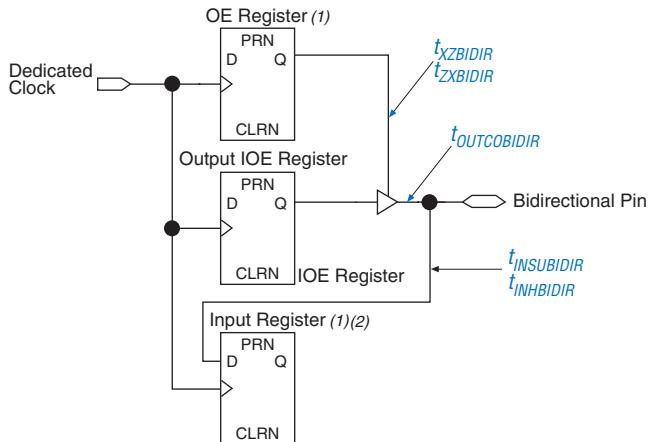


For more information on I/O standards supported by APEX 20KE devices, see *Application Note 117 (Using Selectable I/O Standards in Altera Devices)*.

The APEX 20KE device contains eight I/O banks. In QFP packages, the banks are linked to form four I/O banks. The I/O banks directly support all standards except LVDS and LVPECL. All I/O banks can support LVDS and LVPECL with the addition of external resistors. In addition, one block within a bank contains circuitry to support high-speed True-LVDS and LVPECL inputs, and another block within a particular bank supports high-speed True-LVDS and LVPECL outputs. The LVDS blocks support all of the I/O standards. Each I/O bank has its own VCCIO pins. A single device can support 1.8-V, 2.5-V, and 3.3-V interfaces; each bank can support a different standard independently. Each bank can also use a separate V_{REF} level so that each bank can support any of the terminated standards (such as SSTL-3) independently. Within a bank, any one of the terminated standards can be supported. EP20K300E and larger APEX 20KE devices support the LVDS interface for data pins (smaller devices support LVDS clock pins, but not data pins). All EP20K300E and larger devices support the LVDS interface for data pins up to 155 Mbit per channel; EP20K400E devices and larger with an X-suffix on the ordering code add a serializer/deserializer circuit and PLL for higher-speed support.

Each bank can support multiple standards with the same VCCIO for output pins. Each bank can support one voltage-referenced I/O standard, but it can support multiple I/O standards with the same VCCIO voltage level. For example, when VCCIO is 3.3 V, a bank can support LVTTL, LVC MOS, 3.3-V PCI, and SSTL-3 for inputs and outputs.

When the LVDS banks are not used as LVDS I/O banks, they support all of the other I/O standards. [Figure 29](#) shows the arrangement of the APEX 20KE I/O banks.

Figure 40. Synchronous Bidirectional Pin External Timing**Notes to Figure 40:**

- (1) The output enable and input registers are LE registers in the LAB adjacent to a bidirectional row pin. The output enable register is set with “Output Enable Routing= Signal-Pin” option in the Quartus II software.
- (2) The LAB adjacent input register is set with “Decrease Input Delay to Internal Cells= Off”. This maintains a zero hold time for lab adjacent registers while giving a fast, position independent setup time. A faster setup time with zero hold time is possible by setting “Decrease Input Delay to Internal Cells= ON” and moving the input register farther away from the bidirectional pin. The exact position where zero hold occurs with the minimum setup time, varies with device density and speed grade.

Table 31 describes the f_{MAX} timing parameters shown in Figure 36 on page 68.

Table 31. APEX 20K f_{MAX} Timing Parameters (Part 1 of 2)

| Symbol | Parameter |
|-----------------|--|
| t_{SU} | LE register setup time before clock |
| t_H | LE register hold time after clock |
| t_{CO} | LE register clock-to-output delay |
| t_{LUT} | LUT delay for data-in |
| t_{ESBRC} | ESB Asynchronous read cycle time |
| t_{ESBWC} | ESB Asynchronous write cycle time |
| $t_{ESBWESU}$ | ESB WE setup time before clock when using input register |
| $t_{ESBDATASU}$ | ESB data setup time before clock when using input register |
| $t_{ESBDAWAH}$ | ESB data hold time after clock when using input register |
| $t_{ESBADDRSU}$ | ESB address setup time before clock when using input registers |
| $t_{ESBDAACO1}$ | ESB clock-to-output delay when using output registers |

Table 31. APEX 20K f_{MAX} Timing Parameters (Part 2 of 2)

| Symbol | Parameter |
|-----------------|--|
| $t_{ESBDA}CO_2$ | ESB clock-to-output delay without output registers |
| t_{ESBDD} | ESB data-in to data-out delay for RAM mode |
| t_{PD} | ESB macrocell input to non-registered output |
| $t_{PTERMSU}$ | ESB macrocell register setup time before clock |
| $t_{PTERMCO}$ | ESB macrocell register clock-to-output delay |
| t_{F1-4} | Fanout delay using local interconnect |
| t_{F5-20} | Fanout delay using MegaLab Interconnect |
| t_{F20+} | Fanout delay using FastTrack Interconnect |
| t_{CH} | Minimum clock high time from clock pin |
| t_{CL} | Minimum clock low time from clock pin |
| t_{CLR} | LE clear pulse width |
| t_{PREP} | LE preset pulse width |
| t_{ESBCH} | Clock high time |
| t_{ESBCL} | Clock low time |
| t_{ESBWP} | Write pulse width |
| t_{ESBRP} | Read pulse width |

Tables 32 and 33 describe APEX 20K external timing parameters.

Table 32. APEX 20K External Timing Parameters Note (1)

| Symbol | Clock Parameter |
|---------------|---|
| t_{INSU} | Setup time with global clock at IOE register |
| t_{INH} | Hold time with global clock at IOE register |
| t_{OUTCO} | Clock-to-output delay with global clock at IOE register |

Table 33. APEX 20K External Bidirectional Timing Parameters Note (1)

| Symbol | Parameter | Conditions |
|------------------|--|-----------------------|
| $t_{INSUBIDIR}$ | Setup time for bidirectional pins with global clock at same-row or same-column LE register | |
| $t_{INHBIDIR}$ | Hold time for bidirectional pins with global clock at same-row or same-column LE register | |
| $t_{OUTCOBIDIR}$ | Clock-to-output delay for bidirectional pins with global clock at IOE register | $C_1 = 10 \text{ pF}$ |
| $t_{ZXBIDIR}$ | Synchronous IOE output buffer disable delay | $C_1 = 10 \text{ pF}$ |
| $t_{ZXBBIDIR}$ | Synchronous IOE output buffer enable delay, slow slew rate = off | $C_1 = 10 \text{ pF}$ |

Table 36. APEX 20KE Routing Timing Microparameters Note (1)

| Symbol | Parameter |
|-------------|--|
| t_{F1-4} | Fanout delay using Local Interconnect |
| t_{F5-20} | Fanout delay estimate using MegaLab Interconnect |
| t_{F20+} | Fanout delay estimate using FastTrack Interconnect |

Note to Table 36:

- (1) These parameters are worst-case values for typical applications. Post-compilation timing simulation and timing analysis are required to determine actual worst-case performance.

Table 37. APEX 20KE Functional Timing Microparameters

| Symbol | Parameter |
|--------|--|
| TCH | Minimum clock high time from clock pin |
| TCL | Minimum clock low time from clock pin |
| TCLR | LE clear Pulse Width |
| TPREP | LE preset pulse width |
| TESBCH | Clock high time for ESB |
| TESBCL | Clock low time for ESB |
| TESBWP | Write pulse width |
| TESBRP | Read pulse width |

Tables 38 and 39 describe the APEX 20KE external timing parameters.

Table 38. APEX 20KE External Timing Parameters Note (1)

| Symbol | Clock Parameter | Conditions |
|----------------|--|----------------------|
| t_{INSU} | Setup time with global clock at IOE input register | |
| t_{INH} | Hold time with global clock at IOE input register | |
| t_{OUTCO} | Clock-to-output delay with global clock at IOE output register | $C1 = 10 \text{ pF}$ |
| $t_{INSUPLL}$ | Setup time with PLL clock at IOE input register | |
| t_{INHPLL} | Hold time with PLL clock at IOE input register | |
| $t_{OUTCOPLL}$ | Clock-to-output delay with PLL clock at IOE output register | $C1 = 10 \text{ pF}$ |

Table 52. EP20K30E Minimum Pulse Width Timing Parameters

| Symbol | -1 | | -2 | | -3 | | Unit |
|--------------------|------|-----|------|-----|------|-----|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{CH} | 0.55 | | 0.78 | | 1.15 | | ns |
| t _{CL} | 0.55 | | 0.78 | | 1.15 | | ns |
| t _{CLRP} | 0.22 | | 0.31 | | 0.46 | | ns |
| t _{PREP} | 0.22 | | 0.31 | | 0.46 | | ns |
| t _{ESBCH} | 0.55 | | 0.78 | | 1.15 | | ns |
| t _{ESBCL} | 0.55 | | 0.78 | | 1.15 | | ns |
| t _{ESBWP} | 1.43 | | 2.01 | | 2.97 | | ns |
| t _{ESBRP} | 1.15 | | 1.62 | | 2.39 | | ns |

Table 53. EP20K30E External Timing Parameters

| Symbol | -1 | | -2 | | -3 | | Unit |
|-----------------------|------|------|------|------|------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{INSU} | 2.02 | | 2.13 | | 2.24 | | ns |
| t _{INH} | 0.00 | | 0.00 | | 0.00 | | ns |
| t _{OUTCO} | 2.00 | 4.88 | 2.00 | 5.36 | 2.00 | 5.88 | ns |
| t _{INSUPLL} | 2.11 | | 2.23 | | - | | ns |
| t _{INHPPLL} | 0.00 | | 0.00 | | - | | ns |
| t _{OUTCOPLL} | 0.50 | 2.60 | 0.50 | 2.88 | - | - | ns |

Table 54. EP20K30E External Bidirectional Timing Parameters

| Symbol | -1 | | -2 | | -3 | | Unit |
|----------------------------|------|------|------|------|------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{INSUBIDIR} | 1.85 | | 1.77 | | 1.54 | | ns |
| t _{INHBIDIR} | 0.00 | | 0.00 | | 0.00 | | ns |
| t _{OUTCOBIDIR} | 2.00 | 4.88 | 2.00 | 5.36 | 2.00 | 5.88 | ns |
| t _{XZBIDIR} | | 7.48 | | 8.46 | | 9.83 | ns |
| t _{ZXBIDIR} | | 7.48 | | 8.46 | | 9.83 | ns |
| t _{INSUBIDIRPLL} | 4.12 | | 4.24 | | - | | ns |
| t _{INHBIDIRPLL} | 0.00 | | 0.00 | | - | | ns |
| t _{OUTCOBIDIRPLL} | 0.50 | 2.60 | 0.50 | 2.88 | - | - | ns |
| t _{XZBIDIRPLL} | | 5.21 | | 5.99 | | - | ns |
| t _{ZXBIDIRPLL} | | 5.21 | | 5.99 | | - | ns |

Tables 55 through 60 describe f_{MAX} LE Timing Microparameters, f_{MAX} ESB Timing Microparameters, f_{MAX} Routing Delays, Minimum Pulse Width Timing Parameters, External Timing Parameters, and External Bidirectional Timing Parameters for EP20K60E APEX 20KE devices.

Table 55. EP20K60E f_{MAX} LE Timing Microparameters

| Symbol | -1 | | -2 | | -3 | | Unit |
|------------------|------------|------------|------------|------------|------------|------------|-------------|
| | Min | Max | Min | Max | Min | Max | |
| t _{SU} | 0.17 | | 0.15 | | 0.16 | | ns |
| t _H | 0.32 | | 0.33 | | 0.39 | | ns |
| t _{CO} | | 0.29 | | 0.40 | | 0.60 | ns |
| t _{LUT} | | 0.77 | | 1.07 | | 1.59 | ns |

Table 64. EP20K100E Minimum Pulse Width Timing Parameters

| Symbol | -1 | | -2 | | -3 | | Unit |
|--------------------|------|-----|------|-----|------|-----|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{CH} | 2.00 | | 2.00 | | 2.00 | | ns |
| t _{CL} | 2.00 | | 2.00 | | 2.00 | | ns |
| t _{CLRP} | 0.20 | | 0.20 | | 0.20 | | ns |
| t _{PREP} | 0.20 | | 0.20 | | 0.20 | | ns |
| t _{ESBCH} | 2.00 | | 2.00 | | 2.00 | | ns |
| t _{ESBCL} | 2.00 | | 2.00 | | 2.00 | | ns |
| t _{ESBWP} | 1.29 | | 1.53 | | 1.66 | | ns |
| t _{ESBRP} | 1.11 | | 1.29 | | 1.41 | | ns |

Table 65. EP20K100E External Timing Parameters

| Symbol | -1 | | -2 | | -3 | | Unit |
|-----------------------|------|------|------|------|------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{INSU} | 2.23 | | 2.32 | | 2.43 | | ns |
| t _{INH} | 0.00 | | 0.00 | | 0.00 | | ns |
| t _{OUTCO} | 2.00 | 4.86 | 2.00 | 5.35 | 2.00 | 5.84 | ns |
| t _{INSUPLL} | 1.58 | | 1.66 | | - | | ns |
| t _{INHPPLL} | 0.00 | | 0.00 | | - | | ns |
| t _{OUTCOPLL} | 0.50 | 2.96 | 0.50 | 3.29 | - | - | ns |

Table 66. EP20K100E External Bidirectional Timing Parameters

| Symbol | -1 | | -2 | | -3 | | Unit |
|----------------------------|------|------|------|------|------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{INSUBIDIR} | 2.74 | | 2.96 | | 3.19 | | ns |
| t _{INHBIDIR} | 0.00 | | 0.00 | | 0.00 | | ns |
| t _{OUTCOBIDIR} | 2.00 | 4.86 | 2.00 | 5.35 | 2.00 | 5.84 | ns |
| t _{XZBIDIR} | | 5.00 | | 5.48 | | 5.89 | ns |
| t _{ZXBIDIR} | | 5.00 | | 5.48 | | 5.89 | ns |
| t _{INSUBIDIRPLL} | 4.64 | | 5.03 | | - | | ns |
| t _{INHBIDIRPLL} | 0.00 | | 0.00 | | - | | ns |
| t _{OUTCOBIDIRPLL} | 0.50 | 2.96 | 0.50 | 3.29 | - | - | ns |
| t _{XZBIDIRPLL} | | 3.10 | | 3.42 | | - | ns |
| t _{ZXBIDIRPLL} | | 3.10 | | 3.42 | | - | ns |

Table 78. EP20K200E External Bidirectional Timing Parameters

| Symbol | -1 | | -2 | | -3 | | Unit |
|----------------------------|------|------|------|------|------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{INSUBIDIR} | 2.81 | | 3.19 | | 3.54 | | ns |
| t _{INHBDIR} | 0.00 | | 0.00 | | 0.00 | | ns |
| t _{OUTCOBIDIR} | 2.00 | 5.12 | 2.00 | 5.62 | 2.00 | 6.11 | ns |
| t _{XZBIDIR} | | 7.51 | | 8.32 | | 8.67 | ns |
| t _{ZXBIDIR} | | 7.51 | | 8.32 | | 8.67 | ns |
| t _{INSUBIDIRPLL} | 3.30 | | 3.64 | | - | | ns |
| t _{INHBDIRPLL} | 0.00 | | 0.00 | | - | | ns |
| t _{OUTCOBIDIRPLL} | 0.50 | 3.01 | 0.50 | 3.36 | - | - | ns |
| t _{XZBIDIRPLL} | | 5.40 | | 6.05 | | - | ns |
| t _{ZXBIDIRPLL} | | 5.40 | | 6.05 | | - | ns |

Tables 79 through 84 describe f_{MAX} LE Timing Microparameters, f_{MAX} ESB Timing Microparameters, f_{MAX} Routing Delays, Minimum Pulse Width Timing Parameters, External Timing Parameters, and External Bidirectional Timing Parameters for EP20K300E APEX 20KE devices.

Table 79. EP20K300E f_{MAX} LE Timing Microparameters

| Symbol | -1 | | -2 | | -3 | | Unit |
|------------------|------|------|------|------|------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{SU} | 0.16 | | 0.17 | | 0.18 | | ns |
| t _H | 0.31 | | 0.33 | | 0.38 | | ns |
| t _{CO} | | 0.28 | | 0.38 | | 0.51 | ns |
| t _{LUT} | | 0.79 | | 1.07 | | 1.43 | ns |

Tables 85 through 90 describe f_{MAX} LE Timing Microparameters, f_{MAX} ESB Timing Microparameters, f_{MAX} Routing Delays, Minimum Pulse Width Timing Parameters, External Timing Parameters, and External Bidirectional Timing Parameters for EP20K400E APEX 20KE devices.

Table 85. EP20K400E f_{MAX} LE Timing Microparameters

| Symbol | -1 Speed Grade | | -2 Speed Grade | | -3 Speed Grade | | Unit |
|------------------|----------------|------|----------------|------|----------------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{SU} | 0.23 | | 0.23 | | 0.23 | | ns |
| t _H | 0.23 | | 0.23 | | 0.23 | | ns |
| t _{CO} | | 0.25 | | 0.29 | | 0.32 | ns |
| t _{LUT} | | 0.70 | | 0.83 | | 1.01 | ns |

Table 86. EP20K400E f_{MAX} ESB Timing Microparameters

| Symbol | -1 Speed Grade | | -2 Speed Grade | | -3 Speed Grade | | Unit |
|--------------------------|----------------|------|----------------|------|----------------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{ESBARC} | | 1.67 | | 1.91 | | 1.99 | ns |
| t _{ESBSRC} | | 2.30 | | 2.66 | | 2.93 | ns |
| t _{ESBAWC} | | 3.09 | | 3.58 | | 3.99 | ns |
| t _{ESBSWC} | | 3.01 | | 3.65 | | 4.05 | ns |
| t _{ESBWASU} | 0.54 | | 0.63 | | 0.65 | | ns |
| t _{ESBWAH} | 0.36 | | 0.43 | | 0.42 | | ns |
| t _{ESBWDSU} | 0.69 | | 0.77 | | 0.84 | | ns |
| t _{ESBWDH} | 0.36 | | 0.43 | | 0.42 | | ns |
| t _{ESBRASU} | 1.61 | | 1.77 | | 1.86 | | ns |
| t _{ESBRAH} | 0.00 | | 0.00 | | 0.01 | | ns |
| t _{ESBWESU} | 1.35 | | 1.47 | | 1.61 | | ns |
| t _{ESBWEH} | 0.00 | | 0.00 | | 0.00 | | ns |
| t _{ESBDATASU} | -0.18 | | -0.30 | | -0.27 | | ns |
| t _{ESBDATAH} | 0.13 | | 0.13 | | 0.13 | | ns |
| t _{ESBWADDRSU} | -0.02 | | -0.11 | | -0.03 | | ns |
| t _{ESBRAADDRSU} | 0.06 | | -0.01 | | -0.05 | | ns |
| t _{ESBDAACO1} | | 1.16 | | 1.40 | | 1.54 | ns |
| t _{ESBDAACO2} | | 2.18 | | 2.55 | | 2.85 | ns |
| t _{ESBDD} | | 2.73 | | 3.17 | | 3.58 | ns |
| t _{PD} | | 1.57 | | 1.83 | | 2.07 | ns |
| t _{PTERMSU} | 0.92 | | 0.99 | | 1.18 | | ns |
| t _{PTERMCO} | | 1.18 | | 1.43 | | 1.17 | ns |

Table 90. EP20K400E External Bidirectional Timing Parameters

| Symbol | -1 Speed Grade | | -2 Speed Grade | | -3 Speed Grade | | Unit |
|----------------------------|----------------|------|----------------|------|----------------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{INSUBIDIR} | 2.93 | | 3.23 | | 3.44 | | ns |
| t _{INHBIDIR} | 0.00 | | 0.00 | | 0.00 | | ns |
| t _{OUTCOBIDIR} | 2.00 | 5.25 | 2.00 | 5.79 | 2.00 | 6.32 | ns |
| t _{XZBIDIR} | | 5.95 | | 6.77 | | 7.12 | ns |
| t _{ZXBIDIR} | | 5.95 | | 6.77 | | 7.12 | ns |
| t _{INSUBIDIRPLL} | 4.31 | | 4.76 | | - | | ns |
| t _{INHBIDIRPLL} | 0.00 | | 0.00 | | - | | ns |
| t _{OUTCOBIDIRPLL} | 0.50 | 2.25 | 0.50 | 2.45 | - | - | ns |
| t _{XZBIDIRPLL} | | 2.94 | | 3.43 | | - | ns |
| t _{ZXBIDIRPLL} | | 2.94 | | 3.43 | | - | ns |

Tables 91 through 96 describe f_{MAX} LE Timing Microparameters, f_{MAX} ESB Timing Microparameters, f_{MAX} Routing Delays, Minimum Pulse Width Timing Parameters, External Timing Parameters, and External Bidirectional Timing Parameters for EP20K600E APEX 20KE devices.

Table 91. EP20K600E f_{MAX} LE Timing Microparameters

| Symbol | -1 Speed Grade | | -2 Speed Grade | | -3 Speed Grade | | Unit |
|------------------|----------------|------|----------------|------|----------------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{SU} | 0.16 | | 0.16 | | 0.17 | | ns |
| t _H | 0.29 | | 0.33 | | 0.37 | | ns |
| t _{CO} | | 0.65 | | 0.38 | | 0.49 | ns |
| t _{LUT} | | 0.70 | | 1.00 | | 1.30 | ns |

Table 94. EP20K600E Minimum Pulse Width Timing Parameters

| Symbol | -1 Speed Grade | | -2 Speed Grade | | -3 Speed Grade | | Unit |
|--------------------|----------------|-----|----------------|-----|----------------|-----|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{CH} | 2.00 | | 2.50 | | 2.75 | | ns |
| t _{CL} | 2.00 | | 2.50 | | 2.75 | | ns |
| t _{CLRP} | 0.18 | | 0.26 | | 0.34 | | ns |
| t _{PREP} | 0.18 | | 0.26 | | 0.34 | | ns |
| t _{ESBCH} | 2.00 | | 2.50 | | 2.75 | | ns |
| t _{ESBCL} | 2.00 | | 2.50 | | 2.75 | | ns |
| t _{ESBWP} | 1.17 | | 1.68 | | 2.18 | | ns |
| t _{ESBRP} | 0.95 | | 1.35 | | 1.76 | | ns |

Table 95. EP20K600E External Timing Parameters

| Symbol | -1 Speed Grade | | -2 Speed Grade | | -3 Speed Grade | | Unit |
|-----------------------|----------------|------|----------------|------|----------------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{INSU} | 2.74 | | 2.74 | | 2.87 | | ns |
| t _{INH} | 0.00 | | 0.00 | | 0.00 | | ns |
| t _{OUTCO} | 2.00 | 5.51 | 2.00 | 6.06 | 2.00 | 6.61 | ns |
| t _{INSUPLL} | 1.86 | | 1.96 | | - | | ns |
| t _{INHPLL} | 0.00 | | 0.00 | | - | | ns |
| t _{OUTCOPLL} | 0.50 | 2.62 | 0.50 | 2.91 | - | - | ns |

Table 96. EP20K600E External Bidirectional Timing Parameters

| Symbol | -1 Speed Grade | | -2 Speed Grade | | -3 Speed Grade | | Unit |
|----------------------------|----------------|------|----------------|------|----------------|------|------|
| | Min | Max | Min | Max | Min | Max | |
| t _{INSUBIDIR} | 0.64 | | 0.98 | | 1.08 | | ns |
| t _{INHBIDIR} | 0.00 | | 0.00 | | 0.00 | | ns |
| t _{OUTCOBIDIR} | 2.00 | 5.51 | 2.00 | 6.06 | 2.00 | 6.61 | ns |
| t _{XZBIDIR} | | 6.10 | | 6.74 | | 7.10 | ns |
| t _{ZXBIDIR} | | 6.10 | | 6.74 | | 7.10 | ns |
| t _{INSUBIDIRPLL} | 2.26 | | 2.68 | | - | | ns |
| t _{INHBIDIRPLL} | 0.00 | | 0.00 | | - | | ns |
| t _{OUTCOBIDIRPLL} | 0.50 | 2.62 | 0.50 | 2.91 | - | - | ns |
| t _{XZBIDIRPLL} | | 3.21 | | 3.59 | | - | ns |
| t _{ZXBIDIRPLL} | | 3.21 | | 3.59 | | - | ns |